
2SD669, 2SD669A

Silicon NPN Epitaxial

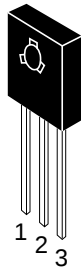
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Application

Low frequency power amplifier complementary pair with 2SB649/A

Outline

TO-126 MOD



- 1. Emitter
- 2. Collector
- 3. Base

2SD669, 2SD669A

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings		Unit
		2SD669	2SD669A	
Collector to base voltage	V _{CBO}	180	180	V
Collector to emitter voltage	V _{CEO}	120	160	V
Emitter to base voltage	V _{EBO}	5	5	V
Collector current	I _C	1.5	1.5	A
Collector peak current	I _{C(peak)}	3	3	A
Collector power dissipation	P _C	1	1	W
	P _C ^{*1}	20	20	W
Junction temperature	T _j	150	150	°C
Storage temperature	T _{stg}	−55 to +150	−55 to +150	°C

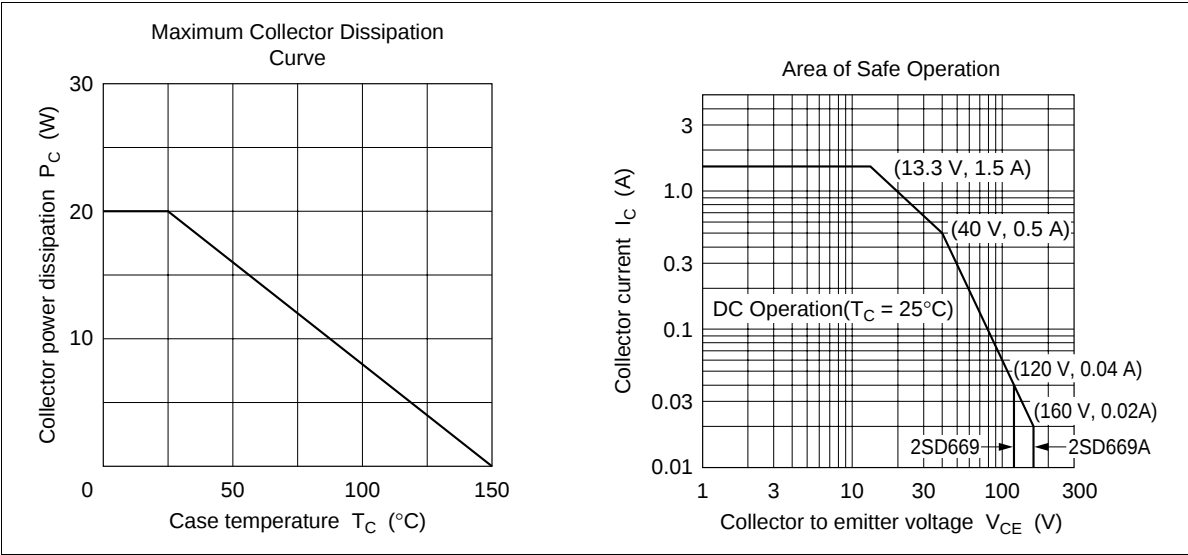
Note: 1. Value at T_C = 25°C.

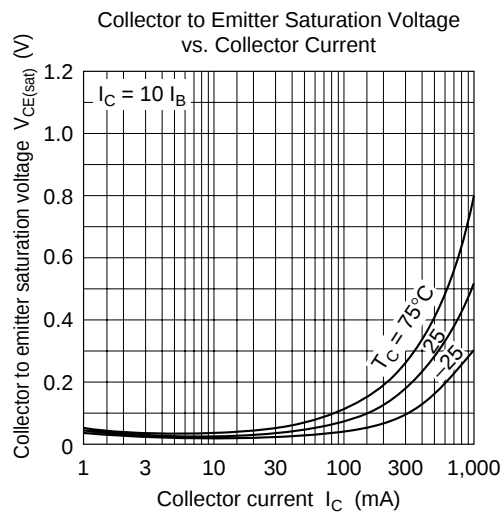
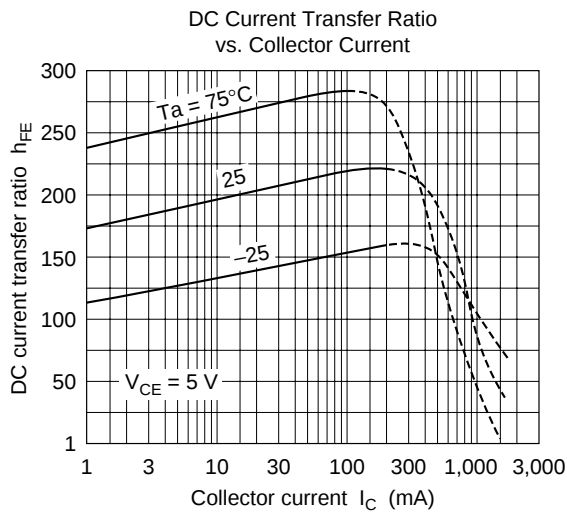
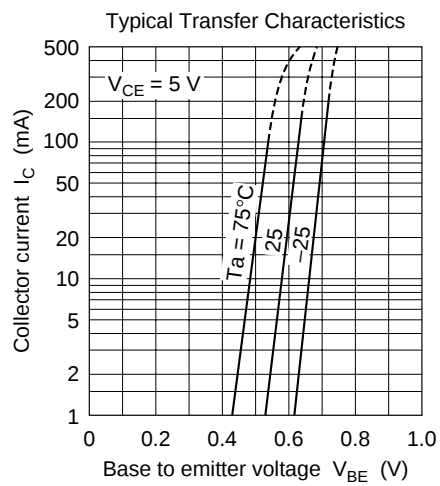
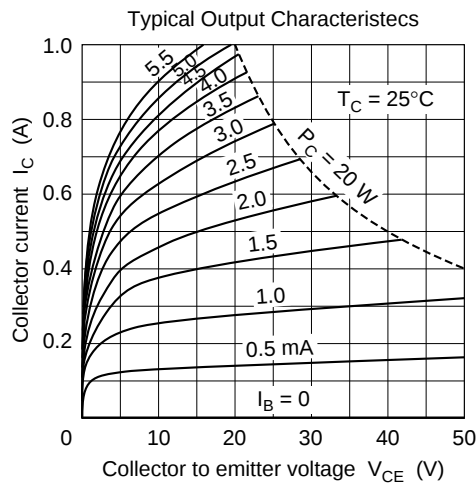
Electrical Characteristics (Ta = 25°C)

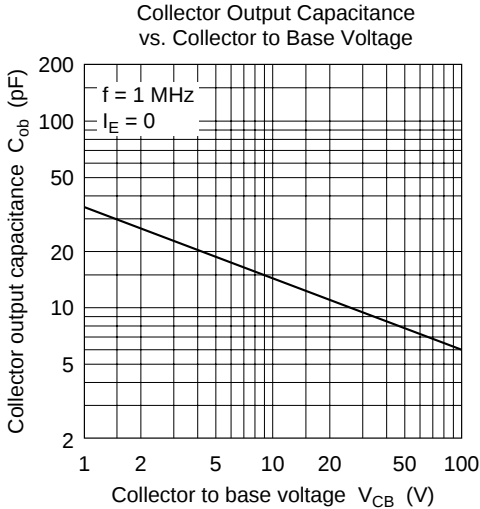
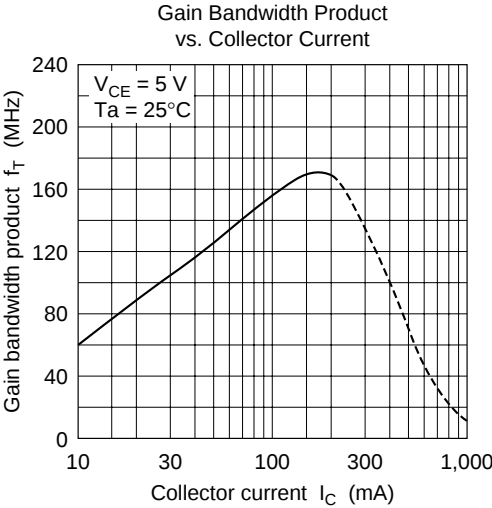
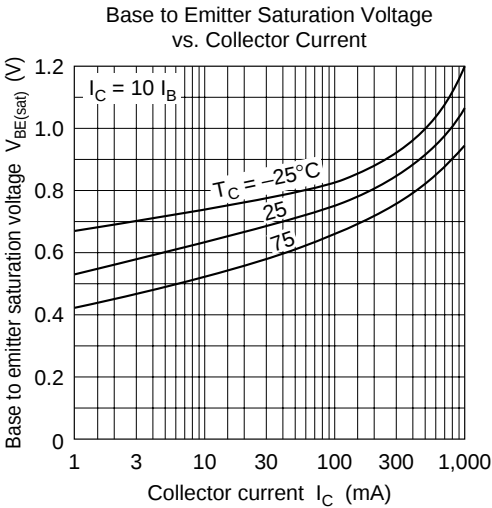
Item	Symbol	2SD669			2SD669A			Unit	Test conditions
		Min	Typ	Max	Min	Typ	Max		
Collector to base breakdown voltage	$V_{(BR)CBO}$	180	—	—	180	—	—	V	$I_C = 1\text{ mA}, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	120	—	—	160	—	—	V	$I_C = 10\text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	—	—	5	—	—	V	$I_E = 1\text{ mA}, I_C = 0$
Collector cutoff current	I_{CBO}	—	—	10	—	—	10	μA	$V_{CB} = 160\text{ V}, I_E = 0$
DC current transfer ratio	h_{FE1}^{*1}	60	—	320	60	—	200		$V_{CE} = 5\text{ V}, I_C = 150\text{ mA}^{*2}$
	h_{FE2}	30	—	—	30	—	—		$V_{CE} = 5\text{ V}, I_C = 500\text{ mA}^{*2}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	1	—	—	1	V	$I_C = 500\text{ mA}, I_B = 50\text{ mA}^{*2}$
Base to emitter voltage	V_{BE}	—	—	1.5	—	—	1.5	V	$V_{CE} = 5\text{ V}, I_C = 150\text{ mA}^{*2}$
Gain bandwidth product	f_T	—	140	—	—	140	—	MHz	$V_{CE} = 5\text{ V}, I_C = 150\text{ mA}^{*2}$
Collector output capacitance	C_{ob}	—	14	—	—	14	—	pF	$V_{CB} = 10\text{ V}, I_E = 0, f = 1\text{ MHz}$

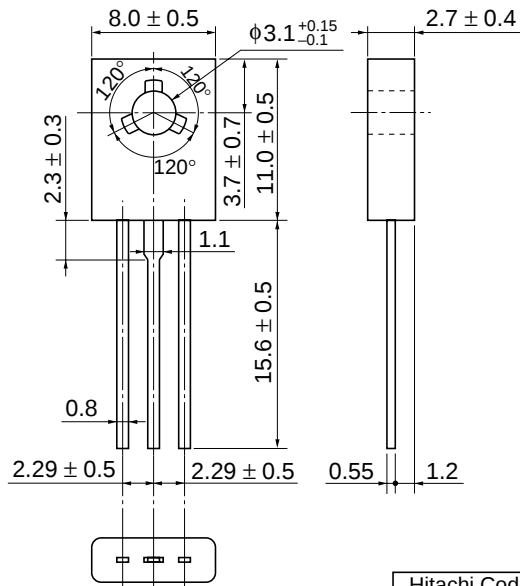
Notes: 1. The 2SD669 and 2SD669A are grouped by h_{FE1} as follows.
2. Pulse test.

	B	C	D
2SD669	60 to 120	100 to 200	160 to 320
2SD669A	60 to 120	100 to 200	—









Hitachi Code	TO-126 Mod
JEDEC	—
EIAJ	—
Weight (reference value)	0.67 g

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Hitachi, Ltd.

Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose, CA 95134 Tel: <1> (408) 433-1990 Fax: <1> (408) 433-0223	Hitachi Europe GmbH Electronic components Group Dornacher Straße 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 778322
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Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533 Hitachi Asia Ltd. Taipei Branch Office 3F, Hung Kuo Building. No.167, Tun-Hwa North Road, Taipei (105) Tel: <886> (2) 2718-3666 Fax: <886> (2) 2718-8180
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Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

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